

PolarP™ **Power MOSFETs**

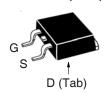
P-Channel Enhancement Mode Avalanche Rated

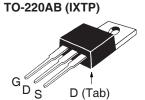
IXTA36P15P IXTP36P15P IXTQ36P15P IXTH36P15P

- 150V - 36A

 $110 \mathrm{m}\Omega$

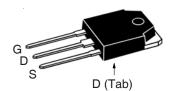
TO-263 AA (IXTA)



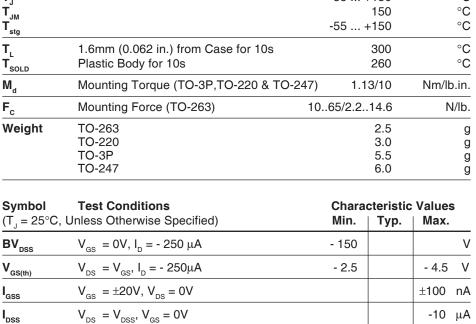




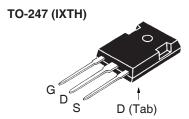
TO-3P (IXTQ)



Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	$T_J = 25^{\circ}C$ to $150^{\circ}C$	- 150	V	
V _{DGR}	$T_J = 25^{\circ}C$ to 150°C, $R_{GS} = 1M\Omega$	- 150	V	
V _{GSS}	Continuous	±20	V	
V _{GSM}	Transient	±30	V	
I _{D25}	T _c = 25°C	- 36	A	
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	- 90	Α	
I _A	T _c = 25°C	- 36	A	
E _{AS}	$T_{c} = 25^{\circ}C$	1.5	J	
dv/dt	$I_{_{\mathrm{S}}} \le I_{_{\mathrm{DM}}}, V_{_{\mathrm{DD}}} \le V_{_{\mathrm{DSS}}}, T_{_{\mathrm{J}}} \le 150^{\circ}\mathrm{C}$	10	V/ns	
P_{D}	$T_c = 25$ °C	300	W	
T _J		-55 +150	°C	
T _{JM}		150	°C	
T _{stg}		-55 +150	°C	
T _L	1.6mm (0.062 in.) from Case for 10s	300	°C	
T _{SOLD}	Plastic Body for 10s	260	°C	
M _d	Mounting Torque (TO-3P,TO-220 & TO-247	7) 1.13/10	Nm/lb.in.	
F _c	Mounting Force (TO-263)	1065/2.214.6	N/lb.	
Weight	TO-263	2.5	g	
	TO-220	3.0	g	
	TO-3P	5.5	g	
	TO-247	6.0	g	



 $T_{J} = 125^{\circ}C$



G = Gate= Drain D S = SourceTab = Drain

Features

- International Standard Packages
- Rugged PolarP™ Process
- Avalanche Rated
- Low Package Inductance
- Fast Intrinsic Diode
- Dynamic dv/dt Rated
- Low R_{DS(ON)} and Q_G
- Low Drain-to-Tab Capacitance

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- High-Side Switching
- Push Pull Amplifiers
- DC Choppers

- 250

μΑ

110 $m\Omega$

- Automatic Test Equipment
- Current Regulators

 $\boldsymbol{R}_{DS(\underline{on})}$

 $V_{GS} = -10V, I_{D} = 0.5 \cdot I_{D25}, \text{ Note 1}$



		Chara Min.	Characteristic Values /lin.			
g _{fs}		$V_{DS} = -10V, I_{D} = 0.5 \cdot I_{D25}, \text{ Note 1}$	11	19	s	
C _{iss}	}			3100	pF	
\mathbf{C}_{oss}		$V_{GS} = 0V, V_{DS} = -25V, f = 1MHz$		610	pF	
\mathbf{C}_{rss}				100	pF	
t _{d(on)}	}	Resistive Switching Times		21	ns	
t _r		$V_{GS} = -10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$ $R_{G} = 3.3\Omega$ (External)		31	ns	
$\mathbf{t}_{d(off)}$				36	ns	
t,	J			15	ns	
$\mathbf{Q}_{g(on)}$	}			55	nC	
\mathbf{Q}_{gs}		$V_{GS} = -10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$		20	nC	
\mathbf{Q}_{gd}				18	nC	
R _{thJC}					0.42 °C/W	
$\mathbf{R}_{ ext{thCS}}$		(TO-3P, TO-247) (TO-220)		0.21 0.50	°C/W °C/W	

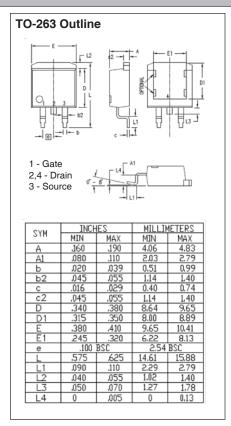
Source-Drain Diode

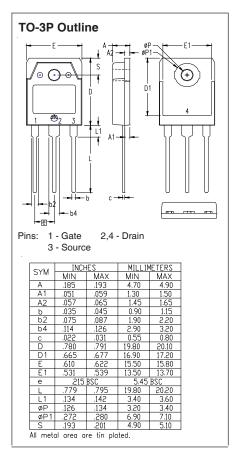
Symbol	Test Conditions	Characteristic Values			
(T _J = 25°C, Unless Otherwise Specified)		Min.	Тур.	Max.	
I _s	$V_{GS} = 0V$			- 36	Α
I _{SM}	Repetitive, Pulse Width Limited by T_{JM}			-140	Α
V _{SD}	$I_{F} = -18A, V_{GS} = 0V, \text{ Note 1}$			- 3.3	V
$\left\{ egin{array}{ll} \mathbf{t}_{rr} & \\ \mathbf{Q}_{RM} & \\ \mathbf{I}_{RM} & \end{array} ight\}$	$I_F = -18A$, $-di/dt = -100A/\mu s$ $V_R = -75V$, $V_{GS} = 0V$		228 2.0 -17.6		ns μC Α

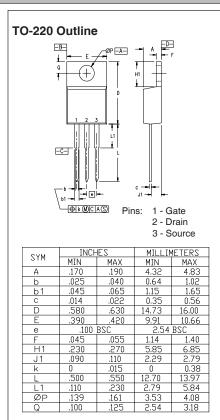
1: Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$. Note



IXTA36P15P IXTP36P15P IXTH36P15P







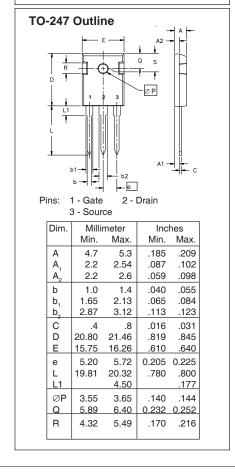




Fig. 1. Output Characteristics @ T_J = 25°C

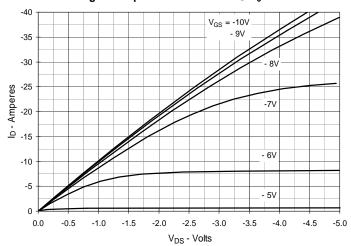


Fig. 2. Extended Output Characteristics @ T_J = 25°C

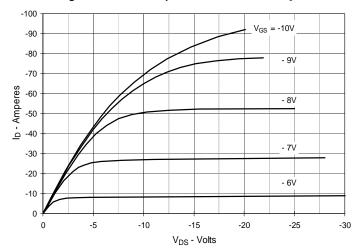


Fig. 3. Output Characteristics @ T_J = 125°C

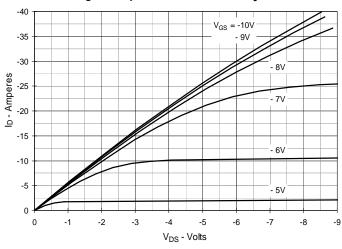


Fig. 4. $R_{DS(on)}$ Normalized to I_D = -18A Value vs. Junction Temperature

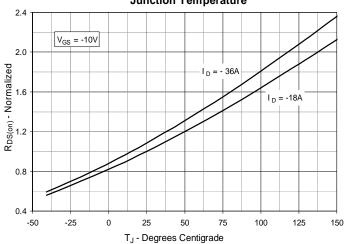


Fig. 5. $R_{DS(on)}$ Normalized to I_D = -18A Value vs.

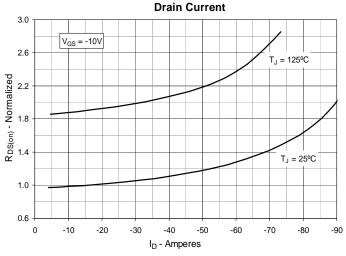
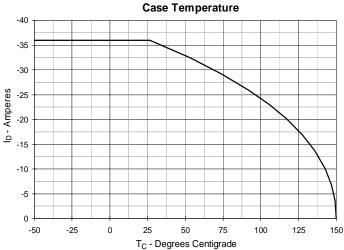
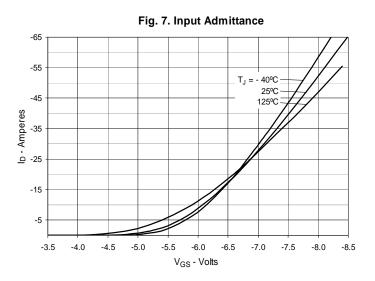


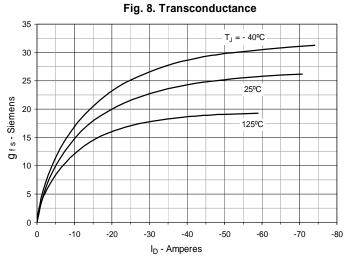
Fig. 6. Maximum Drain Current vs.

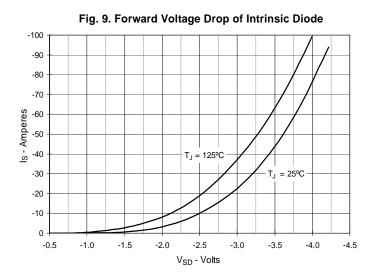


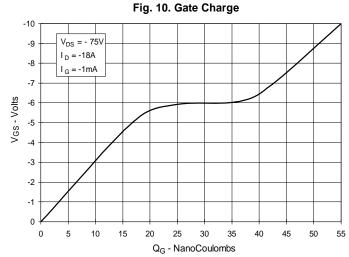
IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

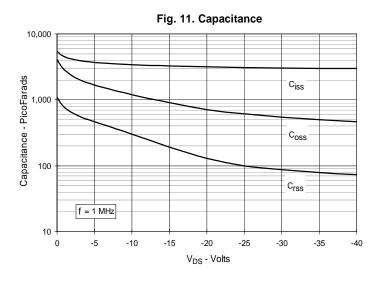


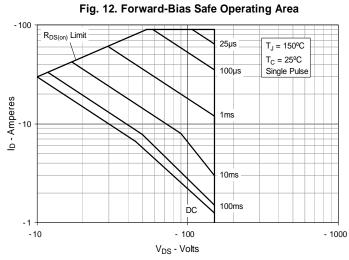














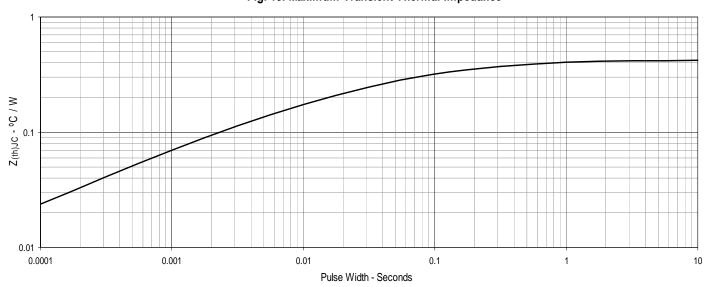


Fig. 13. Maximum Transient Thermal Impedance

